

**$V_{RM} = 200\text{ V}$ ,  $I_{F(AV)} = 1.5\text{ A}$ ,  $t_{rr} = 30\text{ ns}$**   
**Fast Recovery Diode**  
**SJPX-F2**

**Description**

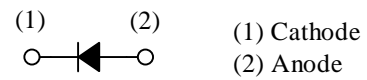
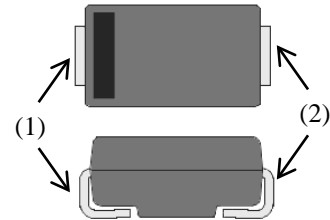
The SJPX-F2 is a fast recovery diode of 200 V / 1.5 A. The maximum  $t_{rr}$  of 30 ns is realized by optimizing a life-time control.

**Features**

- $V_{RM}$ ----- 200 V
- $I_{F(AV)}$ ----- 1.5 A
- $V_F$ -----0.98 V
- $t_{rr1}$ ----- 30 ns
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Suitable for High Reliability and Automotive Requirement.

**Package**

SJP



Not to scale

**Applications**

- White Goods
- Audiovisual Equipment
- Lighting Equipment
- Industrial Electronic Equipment  
(Communication Equipment and Factory Automation)
- Secondary Side Rectifier Diode  
(Flyback Converter, LLC Converter, etc.)
- Freewheel Diode  
(Offline Buck and Buck-boost Converter)

## SJPX-F2

### Absolute Maximum Ratings

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	$V_{RSM}$	200	V	
Repetitive Reverse Voltage	$V_{RM}$	200	V	
Average Forward Current	$I_{F(AV)}$	1.5	A	See Figure 1 and Figure 2
Surge Forward Current	$I_{FSM}$	30	A	Half cycle sine wave, positive side, 10 ms, 1 shot
$I^2t$ Limiting Value	$I^2t$	4.5	$A^2s$	$1\text{ ms} \leq t \leq 10\text{ ms}$
Junction Temperature	$T_J$	-40 to 150	$^\circ\text{C}$	
Storage Temperature	$T_{STG}$	-40 to 150	$^\circ\text{C}$	

### Electrical Characteristics

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	$V_F$	$T_J = 25\text{ }^\circ\text{C}$ , $I_F = 1.5\text{ A}$	—	—	0.98	V
		$T_J = 100\text{ }^\circ\text{C}$ , $I_F = 1.5\text{ A}$	—	0.82	—	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	—	—	10	$\mu\text{A}$
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 150\text{ }^\circ\text{C}$	—	—	2	mA
Reverse Recovery Time	$t_{rr1}$	$I_F = I_{RP} = 100\text{ mA}$ 90% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	30	ns
	$t_{rr2}$	$I_F = 100\text{ mA}$ , $I_{RP} = 200\text{ mA}$ , 75% recovery point, $T_J = 25\text{ }^\circ\text{C}$	—	—	25	ns
Thermal Resistance <sup>(1)</sup>	$R_{th(J-L)}$		—	—	20	$^\circ\text{C/W}$

<sup>(1)</sup>  $R_{th(J-L)}$  is thermal resistance between junction and lead.

Rating and Characteristic Curves

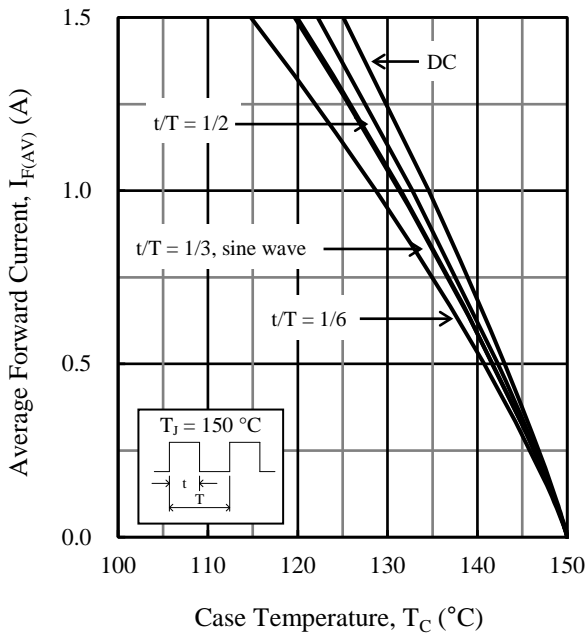


Figure 1.  $T_C$  vs.  $I_{F(AV)}$  Typical Characteristics ( $V_R = 0\text{ V}$ )

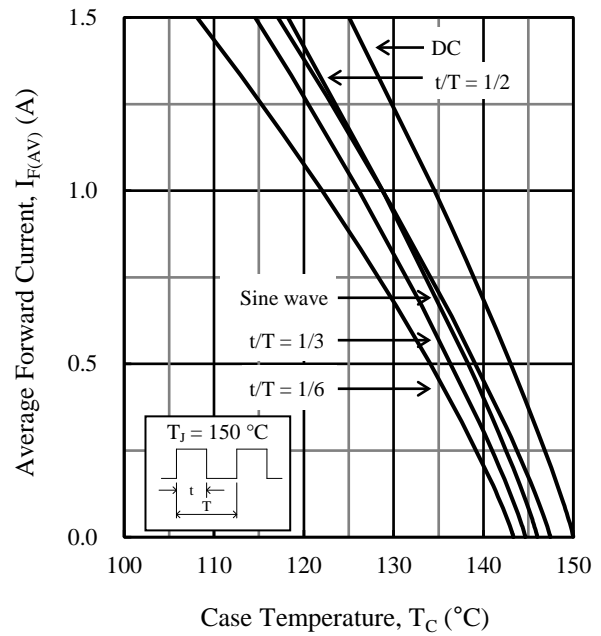


Figure 2.  $T_C$  vs.  $I_{F(AV)}$  Typical Characteristics ( $V_R = 200\text{ V}$ )

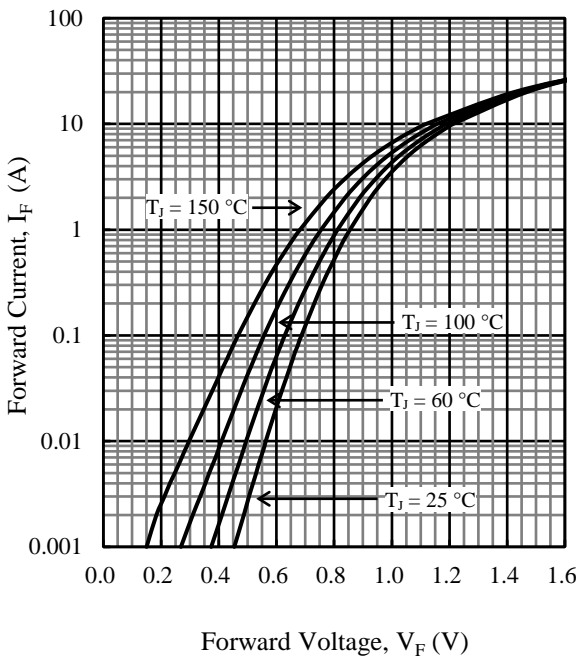


Figure 3.  $V_F$  vs.  $I_F$  Typical Characteristics

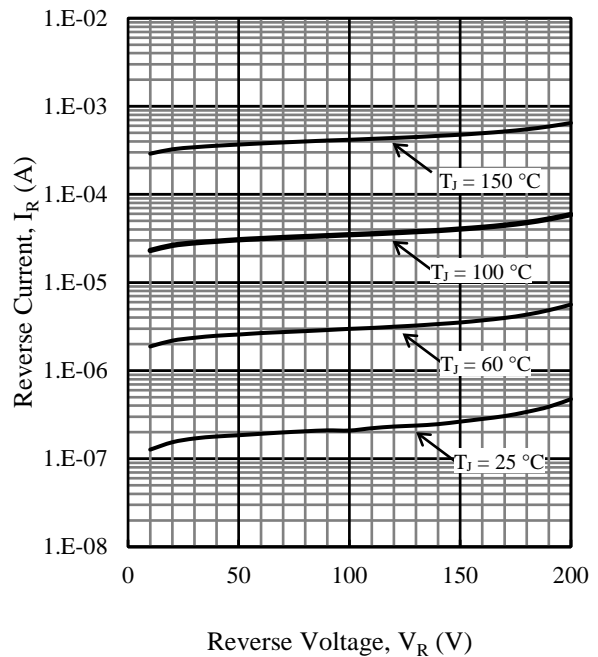
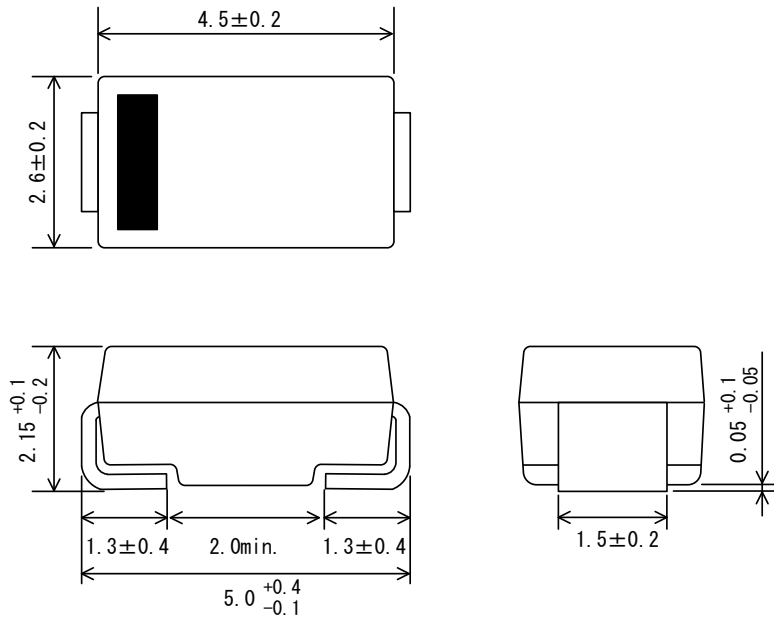


Figure 4.  $V_R$  vs.  $I_R$  Typical Characteristics

## SJPX-F2

### Physical Dimensions

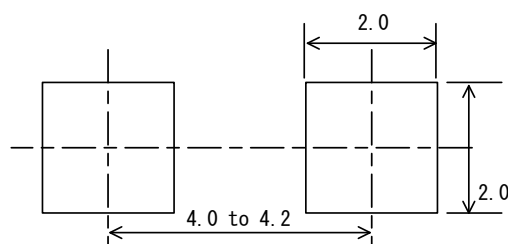
#### • SJP Package



#### NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits:
  - Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times
  - Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time
- MSL: JEDEC LEVEL1

#### • SJP Land Pattern Example



#### NOTE:

- Dimensions in millimeters

## Marking Diagram

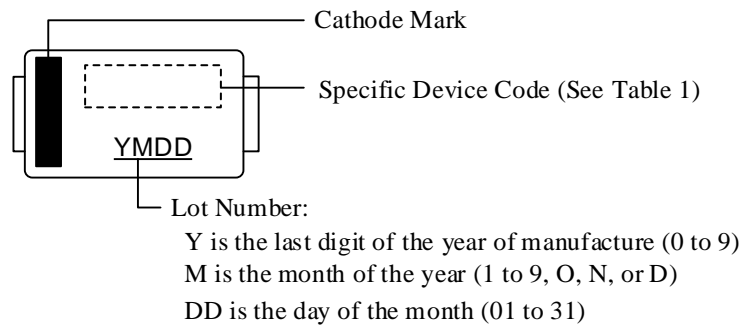


Table 1. Specific Device Code

Specific Device Code	Part Number
XF2	SJPX-F2

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DSGN-AEZ-16003